

SOLIDWORKS GENERATED DRAWING, DO NOT CHANGE BY HAND

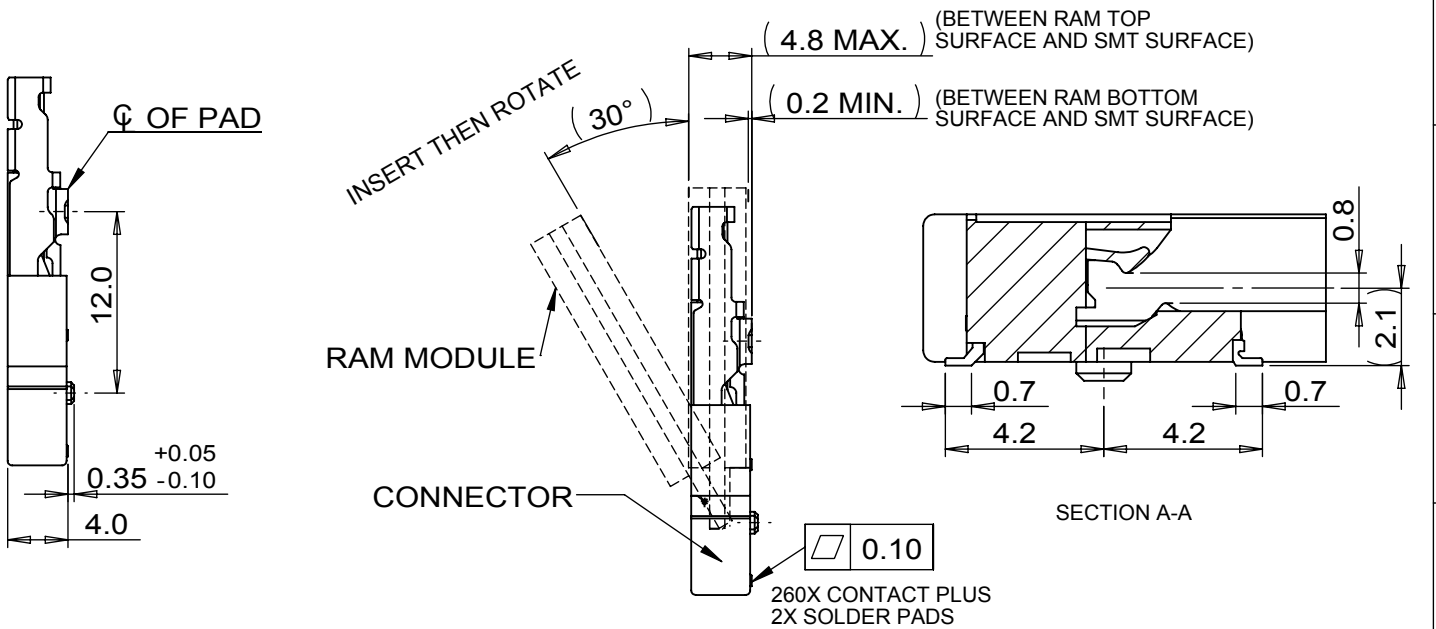
REV.	ECN. NO.	APPD.
A	BC-13-0071338	C.S Li

- NOTES:
1. ELECTRICAL CHARACTERISTICS:
- 1.1. CONTACT CURRENT RATING: 0.5 AMPERE MAX. PER PIN.
- 1.2. VOLTAGE RATING: 25V AC.
- 1.3. INSULATION RESISTANCE: 100 MEGAOHMS MIN. AT 500V DC.
- 1.4. DIELECTRIC WITHSTANDING VOLTAGE: 250V AC RMS AT 60Hz, FOR 1 MINUTE.
- 1.5. CONTACT RESISTANCE: 30 MILLIOHMS MAX. PER PIN INITIAL
Δ10 MILLIOHMS PER PIN AFTER FULL ENVIRONMENTAL TESTING.
2. MECHANICAL CHARACTERISTICS: DURABILITY: 60 MATING CYCLES.
3. OPERATION TEMPERATURE: -55°C TO +85°C.
4. RECOMMENDED PROCESS CONDITION: SMT, PEAK TEMPERATURE: 260°C 10~20S.
5. PLEASE CONTACT FOXCONN SALES REPRESENTATIVE TO VERIFY PRODUCT DETAILS & AVAILABILITY.

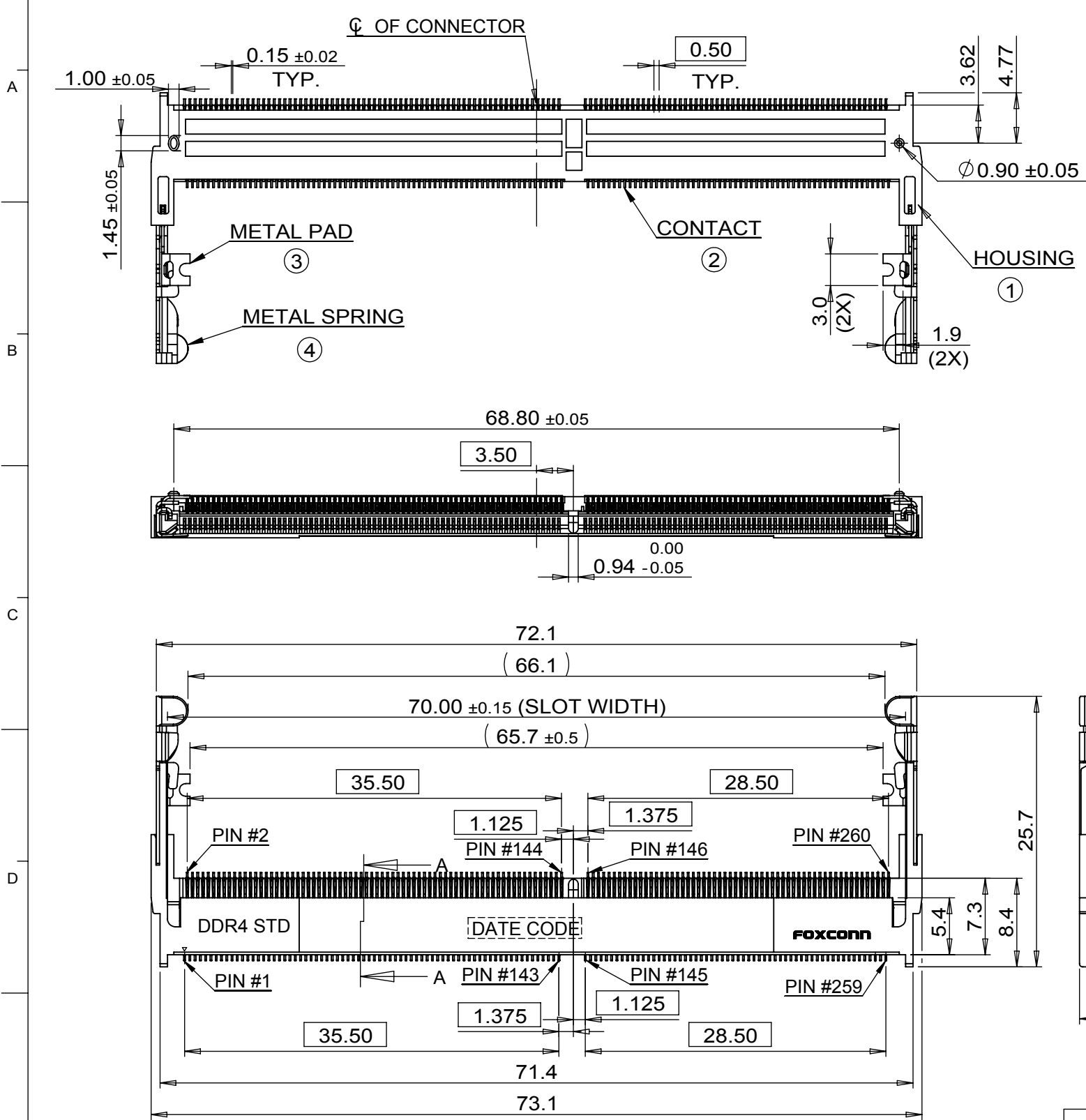
MEMORY MODULE SOCKET
HORIZONTAL TYPE
SINGLE ROW
NO. OF POS.
A8 = 260 POS.
SMT
CONTACT AREA PLATING
7=15u" GOLD PLATING
3= 30u" GOLD PLATING

A S 0 A8 2 * - H 4 S B - 7 H

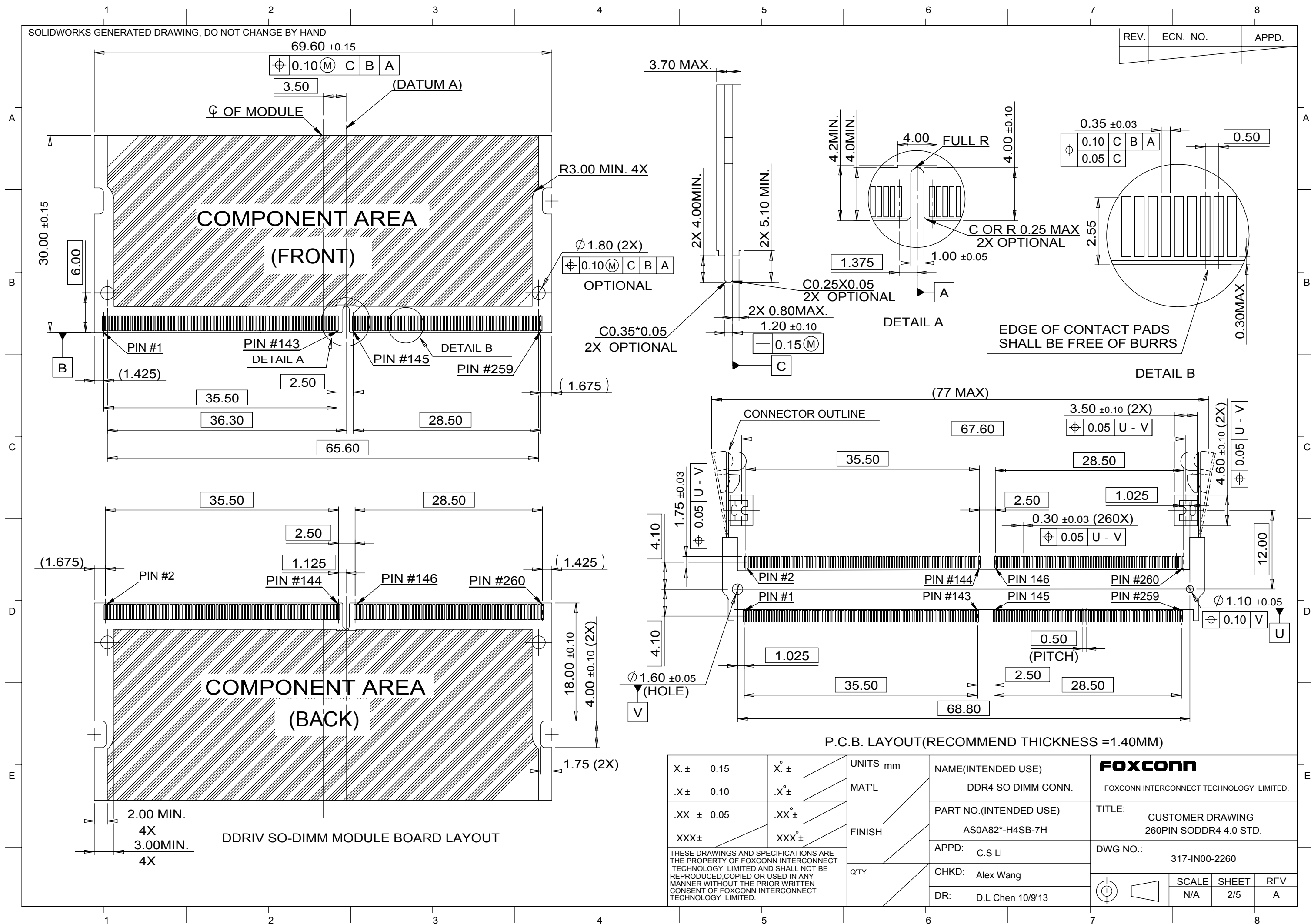
H=HALOGEN/LEAD FREE
7=TAPE REEL
B=BLACK COLOR
S=STANDARD TYPE
4=4.0mm HEIGHT
DDR CONNECTOR



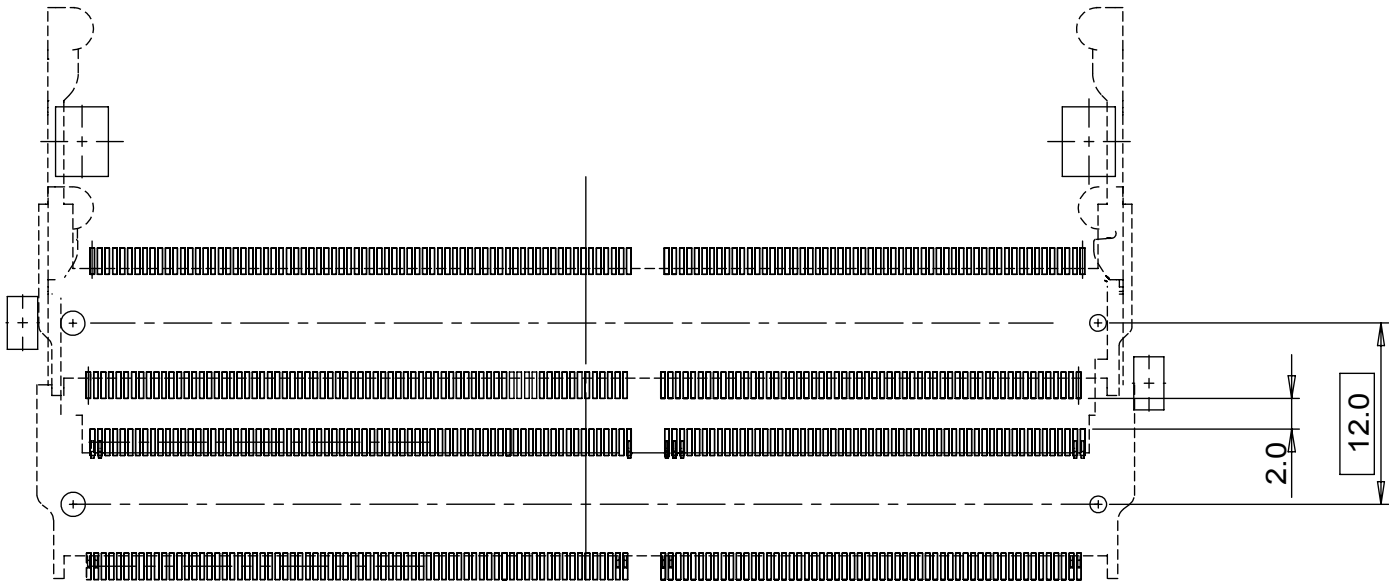
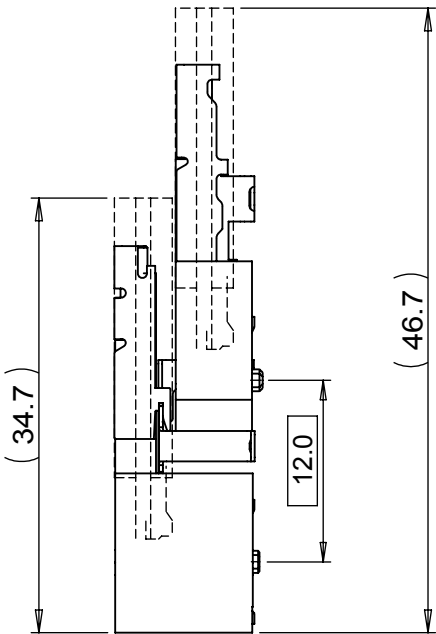
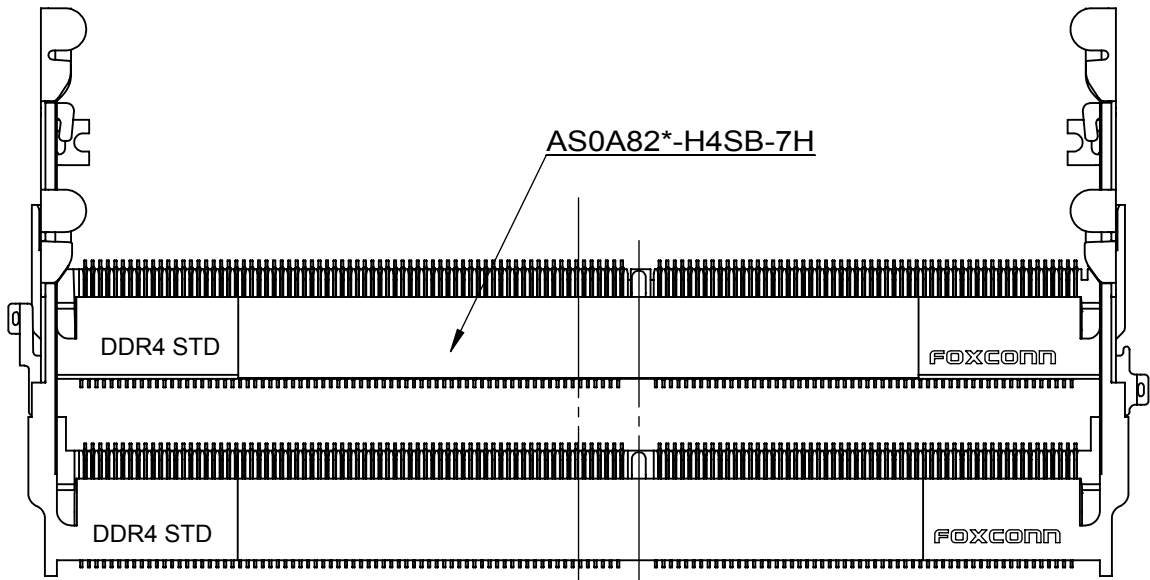
X.± 0.30	X.° ±	UNITS mm	NAME(INTENDED USE)	FOXCONN		
.X± .X 0.25	.X° ±	MAT'L	DDR4 SO DIMM CONN.	FOXCONN INTERCONNECT TECHNOLOGY LIMITED.		
.XX ± 0.15	.XX° ±		PART NO.(INTENDED USE)	TITLE:		
.XXX±	.XXX° ±	FINISH	AS0A82*-H4SB-7H	CUSTOMER DRAWING		
THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF FOXCONN INTERCONNECT TECHNOLOGY LIMITED AND SHALL NOT BE REPRODUCED, COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF FOXCONN INTERCONNECT TECHNOLOGY LIMITED.			APPD: C.S. Li	260PIN SODDR4 4.0 STD.		
			CHKD: Alex Wang	DWG NO.:		
			DR: D.L Chen 10/9'13	317-IN00-2260		
				SCALE	SHEET	REV.
				N/A	1/5	A



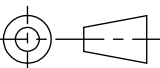
4	METAL SPRING	2	STAINLESS STEEL	ULTRASONIC CLEANING
3	METAL PAD	2	STAINLESS STEEL	10u" NICKEL UNDER PLATING 100u" MATTE TIN PLATING OVER SOLDER PAD AREA
2	CONTACT	260	COPPER ALLOY	50u" NICKEL UNDER PLATING GOLD FLASH PLATING AT TAIL 15u" OR 30u" GOLD PLATING AT CONTACT AREA
1	HOUSING	1	THERMOPLASTIC	UL94V-0, HALOGEN FREE, BLACK COLOR
ITEM	DESCRIPTION	Q'TY	MATERIAL	TREATMENT



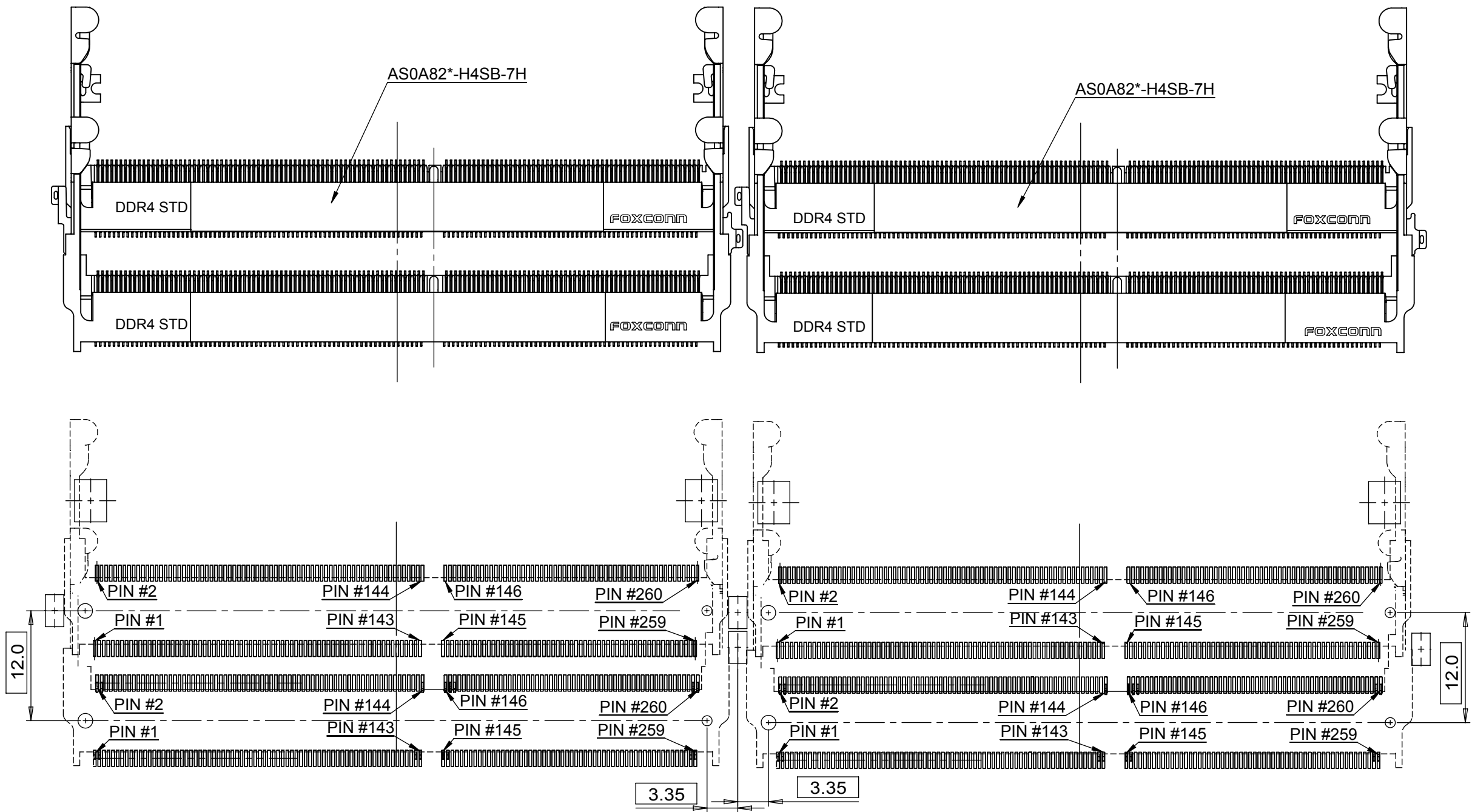
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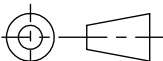


P.C.B. LAYOUT(STACKED ORIENTATION)

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.XX ± 0.05	.XX ° ±		PART NO.(INTENDED USE)	TITLE:		
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		DR: D.L Chen 10/9'13		SCALE	SHEET	REV.
				N/A	3/5	A

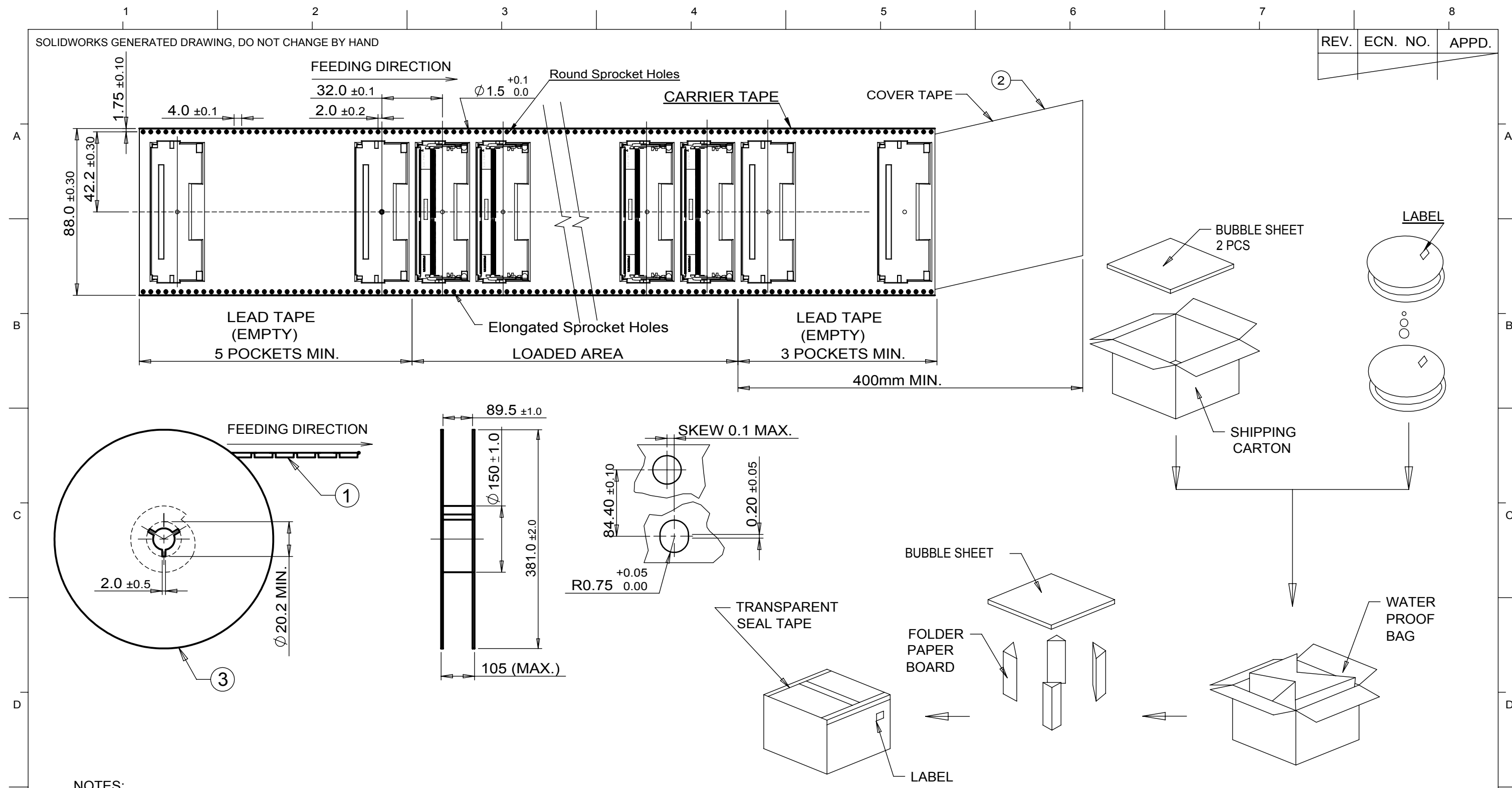
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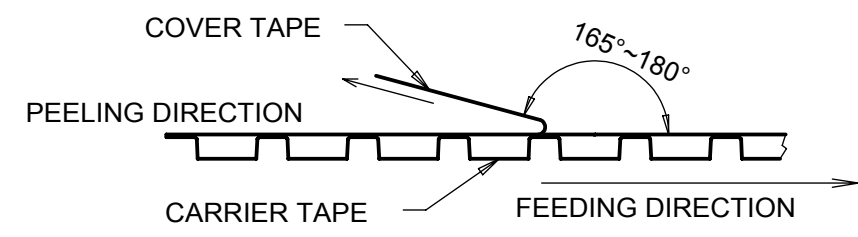
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		Q'TY	C.S Li	317-IN00-2260			
			CHKD:				
			Alex Wang				
		DR:	D.L Chen 10/9'13	SCALE	SHEET	REV.	
				N/A	4/5	A	

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REV.	ECN. NO.	APPD.



- NOTES:
1. 10 POCKETS HOLE PITCH CUMULATIVE TOLERANCE ± 0.20mm.
 2. COVER TAPE PEELING STRENGTH : 0.01 kgf MIN & 0.15 kgf MAX. AT 300mm/min.



3. PACKING CAPACITY : 340 PCS/REEL, 3 REELS/BOX, TOTAL 1020 PCS/BOX.

CONNECTOR P/N AS0A82*-H4SB-7H

ITEM	DESCRIPTION	MATERIAL
3	REEL	POLYSTYRENE
2	COVER TAPE	POLYESTER
1	CARRIER TAPE	POLYSTYRENE

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			CHKD: Alex Wang			
			DR: D.L Chen 10/9'13			